

NCE25TD135LT

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1350V, 25A, Trench FS II Fast IGBT

General Description:

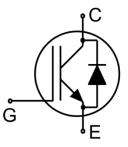
Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 1350V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation;

Features

- Trench FSII Technology offering
- Very low V_{CE(sat)}
- Positive temperature coefficient in V_{CE(sat)}
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

- Inductive Cooking
- Soft Switching Applications



Schematic diagram

Package Marking and Ordering Information

Device	Device Package	Device Marking
NCE25TD135LT	TO-247	NCE25TD135LT



TO-247

Absolute Maximum Ratings (T_C=25°C unless otherwise noted)

Symbol	Parameter	Value	Units	
Vces	Collector-Emitter Voltage	1350	V	
V _{GES}	Gate- Emitter Voltage	±30	V	
Ic	Collector Current	50	Α	
IC	Collector Current @T _C = 100 °C	25	А	
I _{Cpuls}	Pulsed Collector Current, tp limited by T _{jmax}	75	А	
-	turn off safe operating area, V _{CE} =1200V, Tj=150°C	75	А	
l _F	Diode Continuous Forward Current @Tc = 100 °C	25	А	
I _{FM}	Diode Maximum Forward Current	75	А	
C-	Power Dissipation @ T _C = 25°C	365	W	
P _D	Power Dissipation @T _C = 100 °C	183	W	
T _J ,T _{stg}	Operating Junction and Storage Temperature Range	-55 to +175	°C	
T∟	Maximum Temperature for Soldering	260	°C	

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Thermal Characteristic

Symbol	Parameter	Value	Units
Rejc	Thermal Resistance, Junction to case for IGBT	0.41	°C/W
Rejc	Thermal Resistance, Junction to case for Diode	0.86	°C/W
R ₀ JA	Thermal Resistance, Junction to Ambient	40	°C/W

Flectrical Characteristics (Tc=25°C unless otherwise noted)

Symbol	Parameter	Toot Conditions		Value		l lmita
		Test Conditions	Min.	Тур.	Max.	Units
Static Chara	cteristics					
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} =0V,I _{CE} =1mA	1350			V
Ices	Collector-Emitter Leakage Current	V _{GE} =0V,V _{CE} =1350V			5	uA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} =+30V,V _{CE} =0V			200	nA
I _{GES(R)}	Gate to Source Reverse Leakage	V _{GE} =-30V,V _{CE} =0V			200	nA
		V _{GE} =15V,I _C =25A, Tj=25°C		1.60	1.85	
$V_{\text{CE(sat)}}$	Collector-Emitter Saturation Voltage	V _{GE} =15V,I _C =30A, Tj=25°C		1.70		V
		V _{GE} =15V,I _C =25A, Tj=150°C		1.85		
$V_{GE(th)}$	Gate Threshold Voltage	I _C =1mA, V _{CE} =V _{GE}	5.0		6.5	V
Dynamic Ch	aracteristics					
Cies	Input Capacitance	V 20V/V 0V		2674		pF
Coes	Output Capacitance	V _{CE} =30V,V _{GE} =0V, f=1MHz		72		
Cres	Reverse Transfer Capacitance	I=IIVITZ		59		
Q_g	Total Gate Charge			146		nC
Qge	Gate to Emitter Charge	Vcc=960V, Ic=25A V _{GE} =15V		28		nC
Qgc	Gate to Collector Charge	VOL-101		84		nC
Switching Cl	haracteristics					
t _{d(ON)}	Turn-on Delay Time			19		
tr	Rise Time			17		ns
t _{d(OFF)}	Turn-Off Delay Time	V _{CE} =600V,I _C =25A		170		119
t _f	Fall Time	V_{GE} =0/15V, R_g =5 Ω		18		
Eon	Turn-On Switching Loss	Inductive Load		2.0		
E _{off}	Turn-Off Switching Loss			1.5		mJ
Ets	Total Switching Loss			3.5		

Electrical Characteristics of the Diode (T_C= 25°C unless otherwise specified):

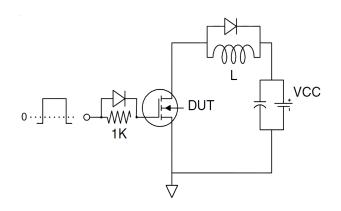
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Тур.	Max.	Ullits
V _{FM}	Diode Forward Voltage	I _F =12.5A		2.5	3.4	٧
Trr	Reverse Recovery Time	I _F =12.5A, di/dt=200A/us		120		ns
I _{RRM}	Diode Peak Reverse Recovery Current			12		Α
Qrr	Reverse Recovery Charge			0.72		uC
Pulse width t _{tp} :	Pulse width $t_{tp} \le 380 \mu s, \delta \le 2\%$					



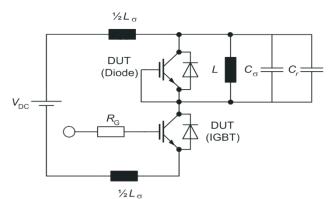


Test Circuit

1) Gate Charge Test Circuit

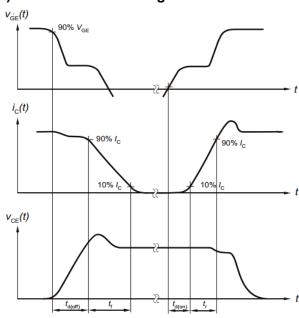


2) Switch Time Test Circuit

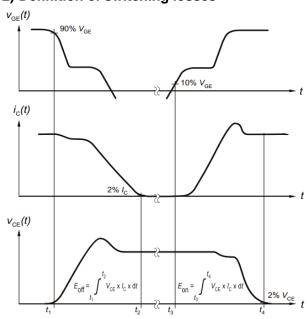


Switching characteristics

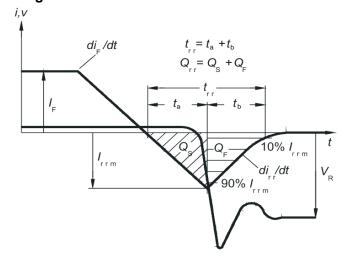
1) Definition of switching times



2) Definition of switching losses



3) Definition of diode switching characteristics



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Typical Electrical and Thermal Characteristics

Figure 1 Output Characteristics

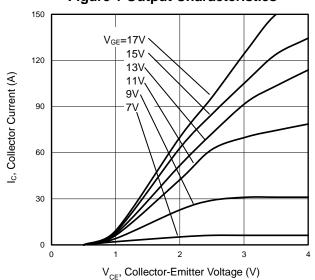


Figure 3 V_{CE(sat)} vs. Case Temperature

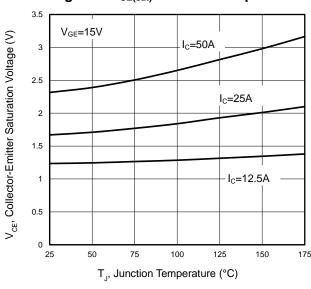


Figure 5 Capacitance Characteristics

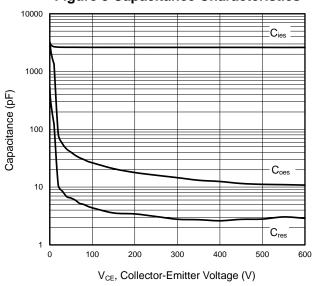


Figure 2 Transfer Characteristics

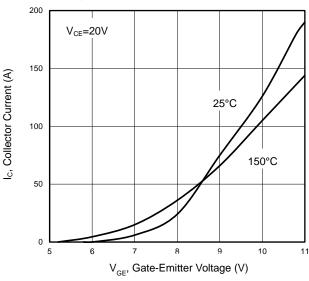


Figure 4 Saturation Voltage vs. V_{GE}

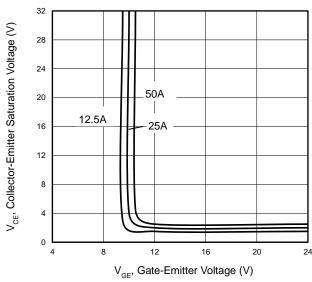
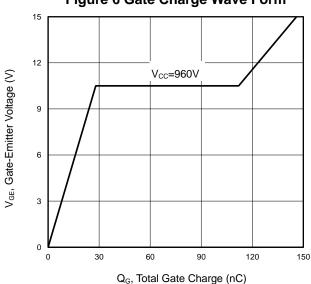


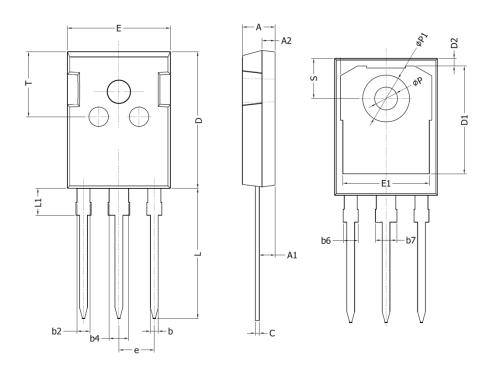
Figure 6 Gate Charge Wave Form



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TO-247-3L Package Information



Comple ed	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	4.90	5.10	0.193	0.201	
A1	2.31	2.51	0.091	0.099	
A2	1.9	2.1	0.075	0.083	
b	1.16	1.26	0.046	0.050	
b2	1.96	2.06	0.077	0.081	
b4	2.96	3.06	0.117	0.120	
b6	-	2.25	-	0.089	
b7	-	3.25	-	0.128	
С	0.59	0.66	0.023	0.026	
D	20.90	21.10	0.823	0.831	
D1	16.25	16.85	0.640	0.663	
D2	1.05	1.35	0.041	0.053	
E	15.70	15.90	0.618	0.626	
E1	13.10	13.50	0.516	0.531	
е	5.436 BSC		0.214 BSC		
L	19.80	20.10	0.780	0.791	
L1	-	4.30	-	0.169	
Р	3.40	3.60	0.134	0.142	
P1	7.00	7.40	0.276	0.291	
S	6.05	6.25	0.238	0.246	
Т	9.80	10.20	0.386	0.402	



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